

SEMICONDUCTOR®

# FQP27N25

# N-Channel QFET<sup>®</sup> MOSFET 250 V, 25.5 A, 110 m $\Omega$

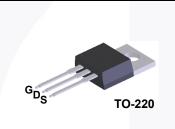
## Description

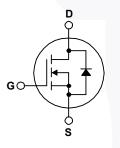
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

### Features

- 25.5 A, 250 V,  $R_{DS(on)}$  = 110 m $\Omega$  (Max.) @  $V_{GS}$  = 10 V,  $I_D$  = 12.75 A
- Low Gate Charge (Typ. 50 nC)
- Low Crss (Typ. 45 pF)
- 100% Avalanche Tested

November 2013





# Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQP27N25	Unit
V <sub>DSS</sub>	Drain-Source Voltage		250	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C	C)	25.5	A
	- Continuous (T <sub>C</sub> = 100	°C)	16.2	A
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	102	A
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	600	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	25.5	A
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	18	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
PD	Power Dissipation (T <sub>C</sub> = 25°C)		180	W
	- Derate above 25°C		1.43	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
Τ <sub>L</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

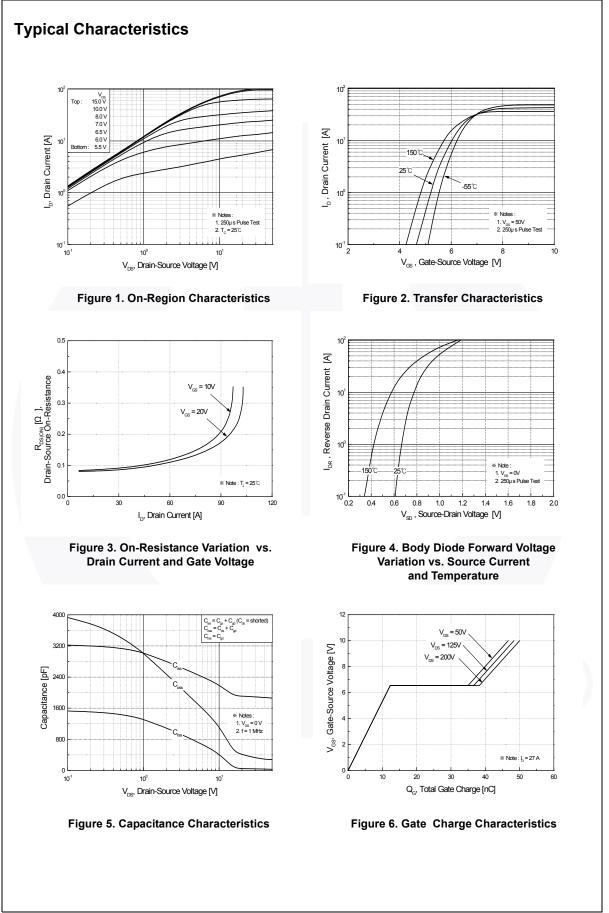
# **Thermal Characteristics**

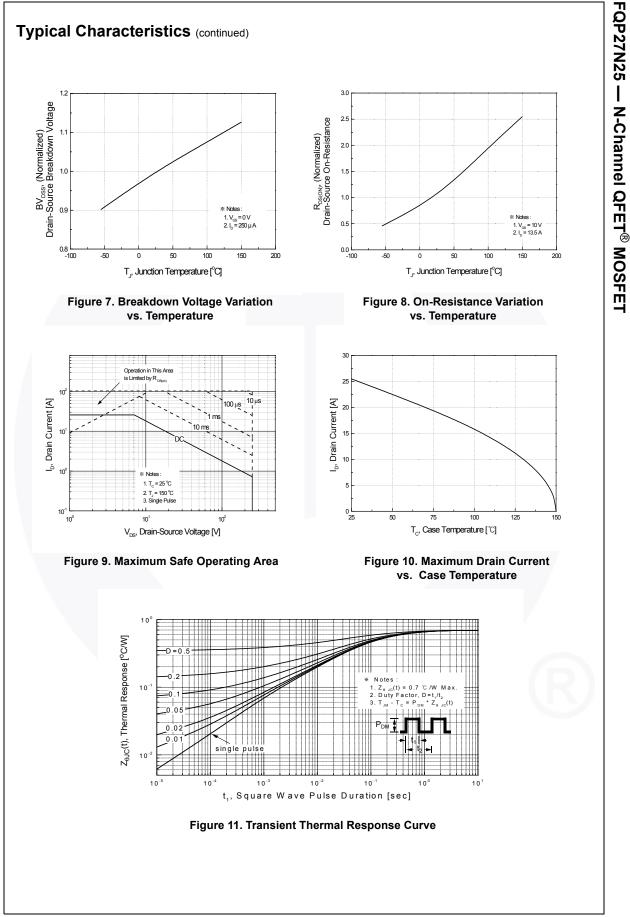
Symbol	Parameter	FQP27N25	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.7	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

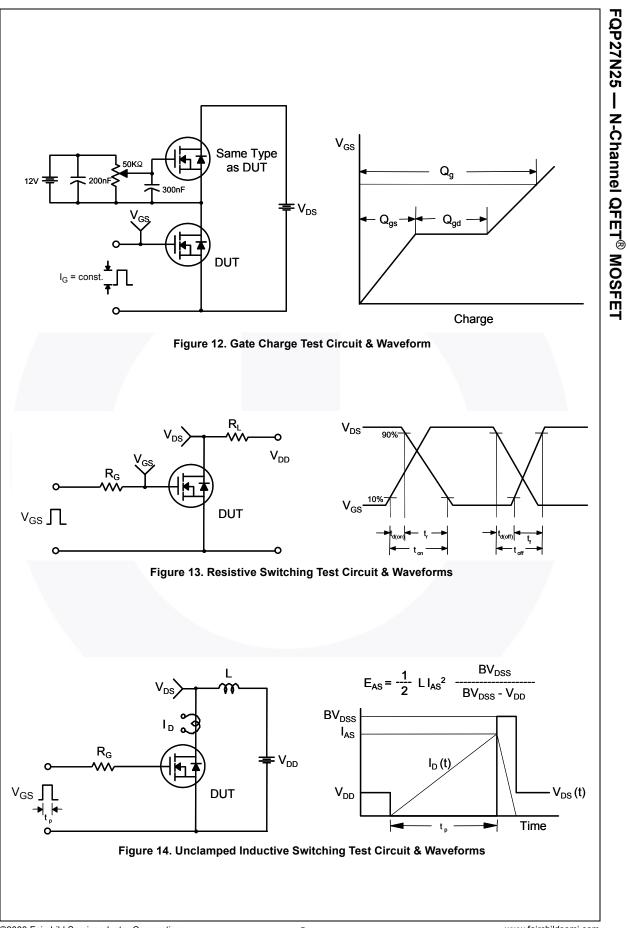
Part NumberTop MarkPackageFQP27N25FQP27N25TO-220		Package	e Packing Method R	Reel Size	Tape Width		h C	Quantity	
		TO-220	Tube N/A		N/A		Ę	50 units	
ectri	cal C	haracteristics	T <sub>C</sub> = 25°C	unless otherwise noted.					
Symbol		Parameter		Test Conditi	ions	Min	Тур	Max	Unit
Off Cha	racto	ristics							
BV <sub>DSS</sub>	1	Source Breakdown Volt	ane	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		250			V
$\Delta BV_{DSS}$						200			v
$/ \Delta T_{J}$	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu A$ , Referenced to $25^{\circ}C$			0.29		V/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			$V_{DS}$ = 250 V, $V_{GS}$ = 0	) V			1	μA
			ent	V <sub>DS</sub> = 200 V, T <sub>C</sub> = 125°C				10	μA
I <sub>GSSF</sub>	Gate-	Body Leakage Current,	Forward	$V_{GS}$ = 30 V, $V_{DS}$ = 0	V			100	nA
I <sub>GSSR</sub>	Gate-I	Body Leakage Current,	Reverse	$V_{GS}$ = -30 V, $V_{DS}$ = 0	V	-		-100	nA
	no cto-	viation							
On Cha V <sub>GS(th)</sub>	1	TISTICS		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250	uА	3.0		5.0	V
		Drain-Source				3.0		5.0	v
R <sub>DS(on)</sub>		esistance		$V_{GS}$ = 10 V, $I_{D}$ = 12.75 A			0.083	0.11	Ω
9 <sub>FS</sub>	Forwa	rd Transconductance		V <sub>DS</sub> = 50 V, I <sub>D</sub> = 12.7	75 A	-	24		S
_									
	1	racteristics					1000	0.450	
C <sub>iss</sub>		Capacitance		$V_{DS} = 25 V, V_{GS} = 0$	V,		1900	2450	pF
C <sub>oss</sub>		t Capacitance		f = 1.0 MHz			360	470	pF
C <sub>rss</sub>	Reven	se Transfer Capacitance	;				45	60	pF
Switch	ing Ch	aracteristics							
t <sub>d(on)</sub>	Turn-C	On Delay Time		V = 125 V L = 27	^		32	75	ns
t <sub>r</sub>	Turn-C	On Rise Time		$V_{DD}$ = 125 V, $I_D$ = 27 R <sub>G</sub> = 25 $\Omega$	А,		270	550	ns
t <sub>d(off)</sub>	Turn-C	Off Delay Time		NG - 25 52			80	170	ns
t <sub>f</sub>	Turn-C	Off Fall Time			(Note 4)		120	250	ns
Qq	Total C	Gate Charge		V <sub>DS</sub> = 200 V, I <sub>D</sub> = 27	А		50	65	nC
Q <sub>gs</sub>	Gate-S	Source Charge		$V_{GS} = 10 V$	,		12.5		nC
Q <sub>gd</sub>	Gate-I	Drain Charge		00	(Note 4)		26		nC
	•		I						
Drain-S	Source	Diode Characteri	stics an	d Maximum Rati	ngs				1
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				25.5	Α			
I <sub>SM</sub>	Maxim	num Pulsed Drain-Sourc	e Diode Fo			1		102	Α
V <sub>SD</sub>	Drain-	Source Diode Forward	Voltage	$V_{GS} = 0 \text{ V, } I_S = 25.5 \text{ A}$ $V_{GS} = 0 \text{ V, } I_S = 27 \text{ A,}$ $dI_F / dt = 100 \text{ A}/\mu\text{s}$				1.5	- V
t <sub>rr</sub>	Reven	se Recovery Time				1	220		ns
Q <sub>rr</sub>	Reven	se Recovery Charge				ł	1.8		μC

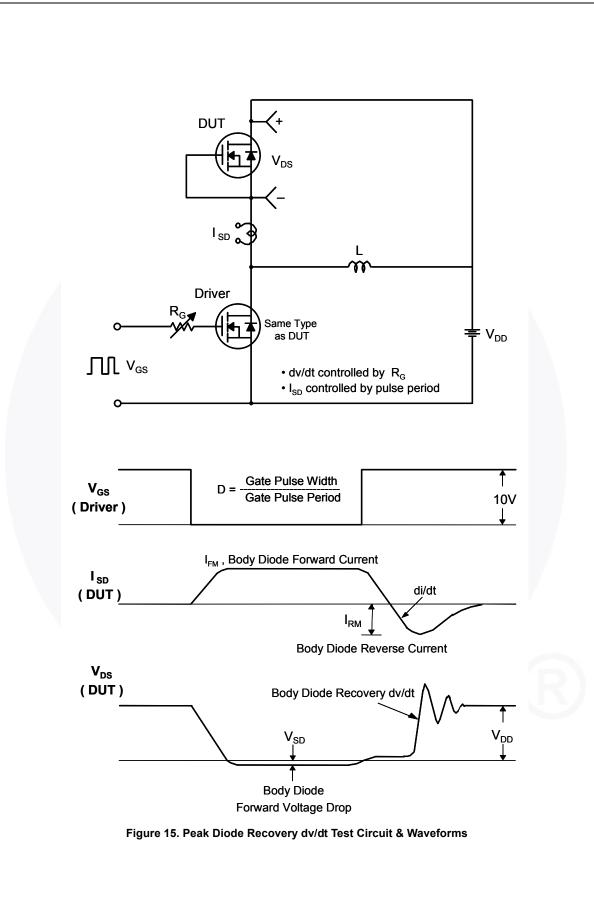
4. Essentially independent of operating temperature.

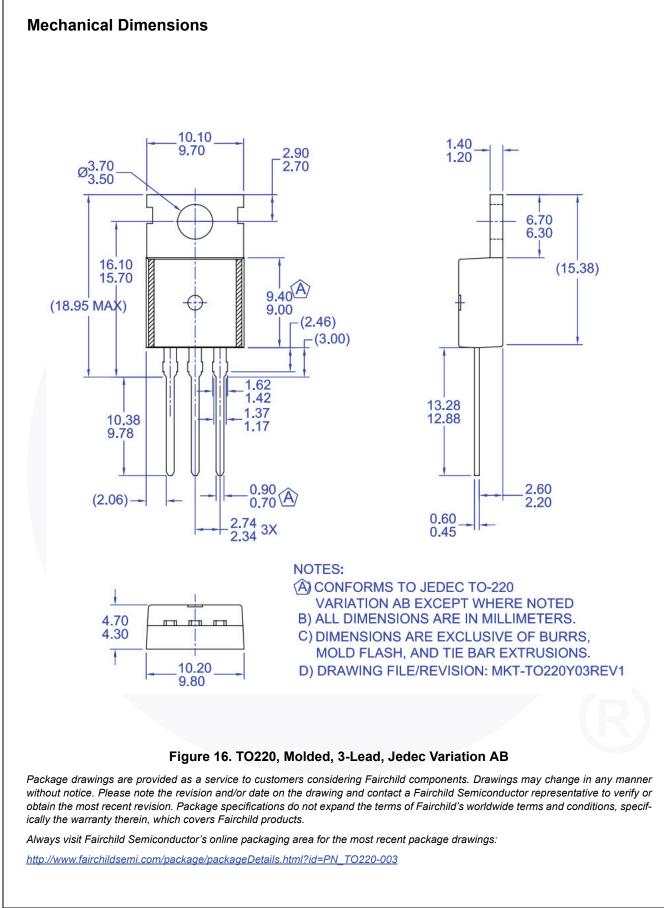
FQP27N25 — N-Channel QFET<sup>®</sup> MOSFET













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